SEMICONDUCTOR

TECHNICAL DATA

FAC1509

2A 150KHZ PWM Buck DC/DC Converter

General Description

The FAC1509 is a of easy to use adjustable step-down (buck) switch-mode voltage regulator. The device is available in an adjustable output version. It is capable of driving a 2A load with excellent line and load regulation.

Requiring a minimum number of external components, these regulators are simple to use and include internal frequency compensation, and a fixed-frequency oscillator.

The output voltage is guaranteed to $\pm 3\%$ tolerance under specified input voltage and output load conditions. The oscillator frequency is guaranteed to $\pm 15\%$. External shutdown is included, featuring typically $50\,\mu\text{A}$ standby current. Self protection features include a two stage frequency reducing current limit for the output switch and an over temperature shutdown for complete protection under fault conditions.

The FAC1509 is available in SOP8 DIP8 package.

Features

- 5V and Adjustable output versions
- Output adjustable from 1.23v to 43V
- Fixed 150KHz frequency internal oscillator
- Guaranteed 2A output load current
- Input voltage range up to 45V
- Low power standby mode, I_Q typically 50 μA
- TTL shutdown capability
- Excellent line and load regulation
- · High efficiency
- Thermal shutdown and current limit protection
- Available in advantaged SOP8 DIP8 package

Applications

- Simple High-efficiency step-down regulator
- On-card switching regulators
- Positive to negative converter
- LCD monitor and LCD TV
- · DVD recorder and PDP TV
- · Battery charger

Package Types

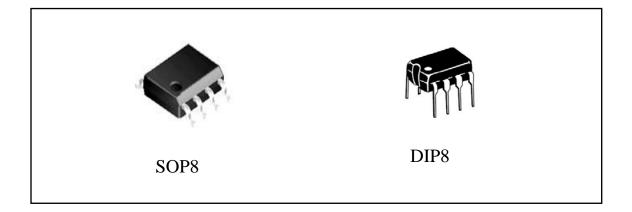
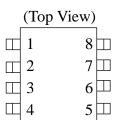


Figure 1. Package Types of FAC1509



Pin Assignments

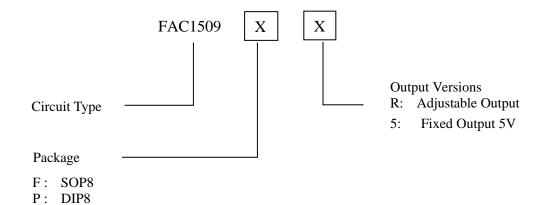


SOP8/DIP8

Pin Descriptions

Pin	Name	Description		
1	V_{IN}	Input supply voltage		
2	Output	Switching output		
5~8	Gnd	Ground		
3	Feedback	Output voltage feedback		
4	ON/OFF	ON/OFF shutdown Active is "Low" or floating		

Ordering Information





Functional Block Diagram

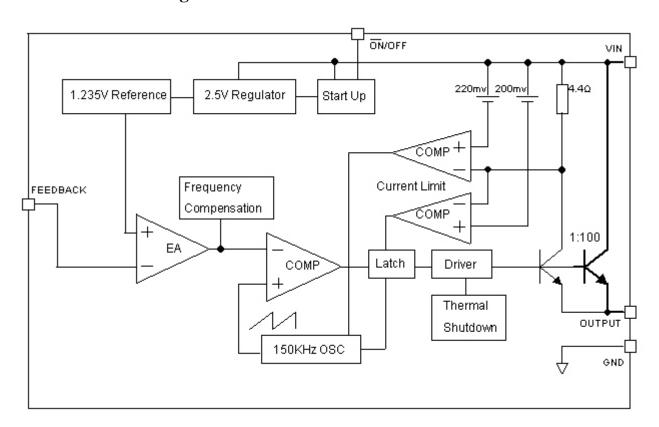
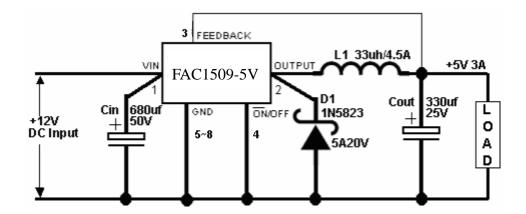


Figure 2. Functional Block Diagram of FAC1509

Typical Application

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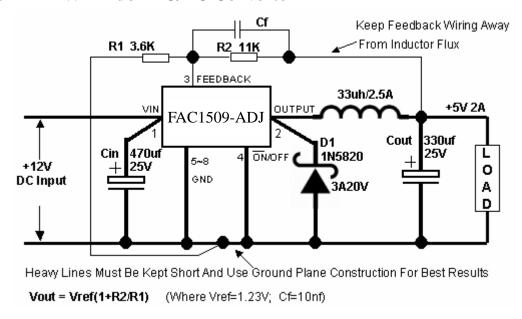


Figure 3. Typical Application of FAC1509



Absolute Maximum Ratings

Note1: Stresses greater than those listed under Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Parameter	Value	Unit
Supply Voltage V _{IN}	-0.3 to 45	V
Feedback VFB pin voltage	-0.3 to V _{IN} +0.3	V
ON/OFF Pin voltage	-0.3 to V _{IN} +0.3	V
Output pin voltage	-0.3 to V _{IN} +0.3	V
Output Voltage to Ground (Steady State)	-1	V
Power Dissipation	Inte rna lly limited	W
Operating Temperature Range	-40 to +125	°C
Storage Temperature	-65 to +150	°C
Lead Temperature (Soldering, 10 sec)	200	°C
ESD(HM)	2000	V

Electrical Characteristics

Unless otherwise specified, $V_{IN} = 12V$. $I_{LOAD} = 0.5A$, $T_A = 25$ °C.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I_D	Feedback bias current	V _{FB} =1.3V		10	50/ 100	nA
I_Q	Quiescent current	V _{FB} =12V force driver off		5	10	mA
I_{STBY}	Standby quiescent current	ON/OFF=5V, V _{IN} =36V		50	100	μΑ
Fosc	Oscillator frequency		127	150	173	KHz
V_{SAT}	Saturation voltage	I _{OUT} =2A		1.10	1.3	V
I_{CL}	Current Limit	Peak Current (V _{FB} =0V)		3.8		A
$ m I_L$	Output leakage current	Output=0V (V _{FB} =12V)			50	μΑ
I_L	Output leakage current	Output=-1V (V _{IN} =32V)		2	30	mA
V _{IL} V _{IH}	ON/OFF pin logic input Threshold voltage	Low (Regulator ON)		1.8	0.6	V
		High (Regulator OFF)	2.0	1.8		V



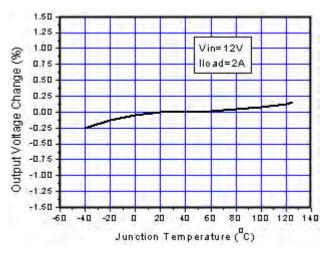
I_{H}	ON/OFF pin input current	V _{LOGIC} =2.5V(Regulator OFF)		5	15	uA
$I_{\rm L}$		V _{LOGIC} =0.5V(Regulator ON)		0.02	5	uA
$\theta_{ m JC}$	Thermal Resistance Junction to Case	SOP8/DIP8		10		°C/W
$ heta_{ m JA}$	Thermal Resistance Junction to Ambient (Note1)	SOP8/DIP8		40		°C/W
ADJ	Vfb: Output Voltage	$\begin{array}{l} 11V \leq V_{IN} \leq 45V, \ 0.2A \leq I_{LOAD} \\ \leq 2A, \ V_{OUT} \ for \ 9V \end{array}$	1.193 / 1.180	1.23	1.267 / 1.280	V
	η: Efficiency	$V_{IN}=12V, V_{OUT}=9V, I_{LOAD}=2A$		89		%
5V	Vout: Output Voltage	7V≤V _{IN} ≤45V, 0.2A≤I _{LOAD} ≤2A	4.800 / 4.750	5.0	5.200 / 5.250	V
	η: Efficiency	$V_{IN}=12V$, $I_{LOAD}=2A$		85		%

Specifications with boldface type are for full operationg temperature range, the other type are for $T_J=25$ °C.

Note1: Thermal resistance with copper area of approximately 3 in².



Typical Performance Characteristics



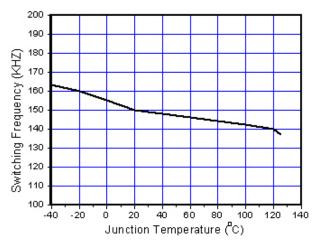


Figure 4. Output Voltage vs. Temperature

Figure 5. Switching Frequency vs. Temperature

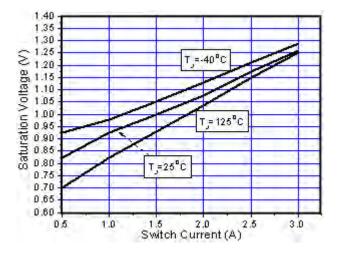


Figure 6. Output Saturation Characteristics

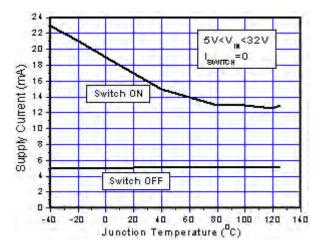


Figure 7. Quiescent Current vs. Temperature



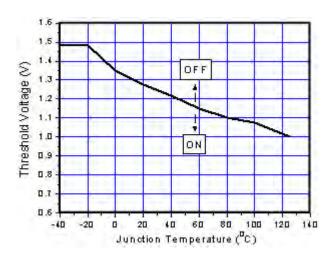


Figure 8. ON/OFF Pin Voltage

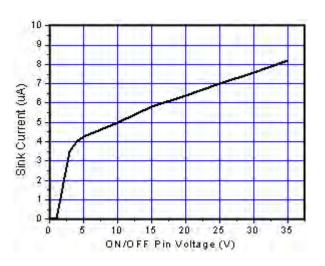


Figure 9. ON/OFF Pin Sink Current

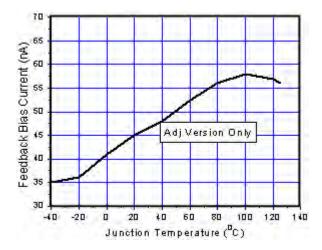


Figure 10. Output Saturation Characteristics



Typical Application Circuit (Adjustable Output Voltage Version)

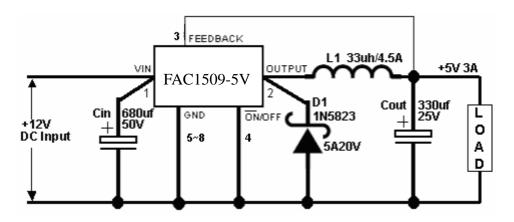


Figure 11. Typical Application of FAC1509 For 5V

Input Voltage	Inductor (L1)	Output Capacitor (Cout)		
input voitage		Through Hole Electrolytic	Surface Mount Tantalum	
8V ~ 18V	33uh	330uf/25V	220uf/10V	
8V ~ 45V	47uh	470uf/25V	330uf/10V	

Table 1. FAC1509 Series Buck Regulator Design Procedure For 5V



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2A 150KHZ PWM Buck DC/DC Converter

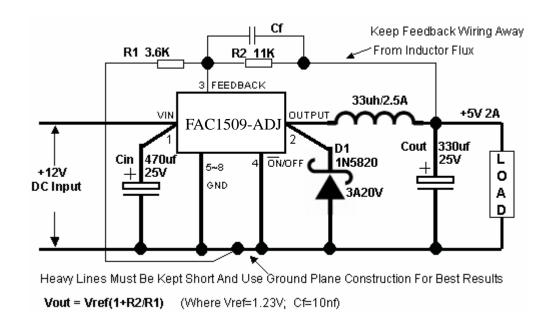


Figure 12. Typical Application of FAC1509 For ADJ

Vout	R1	R2	Cf (Operational)
3.3V	1.6K	2.7K	33nf
5V	3.6K	11K	10nf
9V	6.8K	43K	1.5nf
12V	1.5K	13K	1nf

Table 2. Vout VS. R1, R2, Cf Select Table

Output	Input	Inductor (L1)	Output Capacitor (Cout)
Voltage	Voltage	mauctor (L1)	Through Hole Electrolytic
3.3V	6V ~ 18V	47uh	470uf/25V
	6V ~36V	68uh	560uf/25V
5V	8V ~ 18V	33uh	330uf/25V
	8V ~36V	47uh	470uf/25V
9V	12V ~18V	47uh	330uf/25V
	12V ~36V	47uh	470uf/25V
12V	15V ~ 18V	47uh	220uf/25V
	15V ~36V	47uh	330uf/25V

Table 3. Typical Application Buck Regulator Design Procedure

FAC1509



2A 150KHZ PWM Buck DC/DC Converter

Function Description

Pin Functions

$+V_{IN}$

This is the positive input supply for the IC switching regulator. A suitable input bypass capacitor must be present at this pin to minimize voltage transients and to supply the switching currents needed by the regulator

Ground

Circuit ground.

Output

Internal switch. The voltage at this pin switches between ($+V_{IN}-V_{SAT}$) and approximately -0.5V, with a duty cycle of approximately V_{OUT}/V_{IN} . To minimize coupling to sensitive circuitry, the PC board copper area connected to this pin should be kept a minimum.

Feedback

Senses the regulated output voltage to complete the feedback loop.

ON/OFF

Allows the switching regulator circuit to be shutdown using logic level signals thus dropping the total input supply current to approximately 50uA. Pulling this pin below a threshold voltage of approximately 1.3V turns the regulator on, and pulling this pin above 1.3V (up to a maximum of 32V) shuts the regulator down. If this shutdown feature is not needed, the ON /OFF pin can be wired to the ground pin or it can be left open, in either case the regulator will be in the ON condition.

Thermal Considerations

The FAC1509 is available in SOP8/DIP8 package.

The SOP8 package needs a heat sink under most conditions. The size of the heat sink depends on the input voltage, the output voltage, the load current and the ambient temperature. The FAC1509 junction temperature rises above ambient temperature for a 2A load and different input and output voltages. The data for these curves was taken with the FAC1509 (SOP8/DIP8 package) operating as a buck-switching regulator in an ambient temperature of 25°C (still air). These temperature rise numbers are all approximate and there are many factors that can affect these temperatures. Higher ambient temperatures require more heat sinking.

For the best thermal performance, wide copper traces and generous amounts of printed circuit board copper should be used in the board layout. (Once exception to this is the output (switch) pin, which should not have large areas of copper.) Large areas of copper provide the best transfer of heat (lower thermal resistance) to the surrounding air, and moving air lowers the thermal resistance even further.

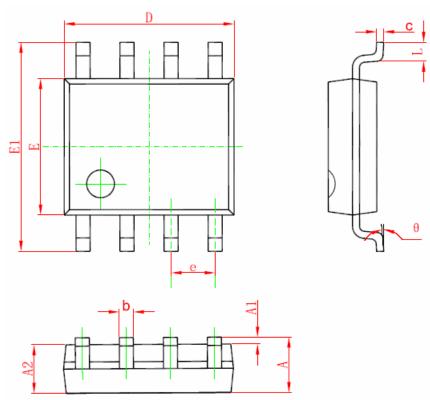
Package thermal resistance and junction temperature rise numbers are all approximate, and there are many factors that will affect these numbers. Some of these factors include board size, shape, thickness, position, location, and even board temperature. Other factors are, trace width, total printed circuit copper area, copper thickness, single or double-sided, multi-layer board and the amount of solder on the board.

The effectiveness of the PC board to dissipate heat also depends on the size, quantity and spacing of other components on the board, as well as whether the surrounding air is still or moving. Furthermore, some of these components such as the catch diode will add heat to the PC board and the heat can vary as the input voltage changes. For the inductor, depending on the physical size, type of core material and the DC resistance, it could either act as a heat sink taking heat away from the board, or it could add heat to the board.



Package Information

SOP8 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
С	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
Е	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		1.270 (BSC) 0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

MILLIMETERS

DIM

INCHES



2A 150KHZ PWM Buck DC/DC Converter

Package Information

DIP8 Package Outline Dimensions

